502870192 06/27/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
VEIT BOLIK	06/26/2014

RECEIVING PARTY DATA

Name:	SAP AG
Street Address:	DIETMAR-HOPP-ALLEE 16
City:	WALLDORF
State/Country:	GERMANY
Postal Code:	69190

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14316817

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	RSAP-0024-US
NAME OF SUBMITTER:	DAVID P. DICKERSON
SIGNATURE:	/David P. Dickerson/
DATE SIGNED:	06/27/2014

Total Attachments: 1

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PATENT 502870192 REEL: 033193 FRAME: 0352

ASSIGNMENT

For valuable consideration the receipt of which is hereby acknowledged, I, Veit BOLIK, residing at BIRKENWEG 11 in 67227 Frankenthal, Germany, hereby assign to SAP AG, having its place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany, and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of the U.S. Patent Application (to be filed) entitled

"Transparent access to multi-temperature data" (SAP ref: 130823,/130823US01).

This Assignment includes said application, any application claiming priority from said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions, and the right to claim priority based on the filing date of said applications under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes. I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations and like rights of exclusion, and for inventors' certificates for any inventions described in said application, and I agree for me and my respective heirs, legal representatives and assigns, without further compensation, to perform such lawful acts and to sign such further applications, assignments, preliminary statements and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

I covenant with said Assignee that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me.

IN WITNESS WHEREOF, I hereto set my hand and seal at WALLDORF, this
Veit BOLIK
Before me this
Witness' signature:
Witness' name (please print): Christopher Lee Marmol Carmona

75239 Eisingen, Germany

Witness' address (please print): Schuberstrasse 8

RECORDED: 06/27/2014

PATENT REEL: 033193 FRAME: 0353